

**WHAT IS CLAIMED IS:**

- 1        1. A method for fabricating a sensor on a substrate having a pair of  
2 electrodes, said method comprising:
  - 3                depositing a first layer of conducting material onto said substrate having a  
4 pair of electrodes; and
  - 5                depositing a second layer of polymer film onto said first layer of  
6 conducting material thereby fabricating said sensor.
- 1        2. The method according to claim 1, wherein said conducting material  
2 comprises carbon black.
- 1        3. The method according to claim 1, wherein said deposition of said  
2 conducting material is by aerosol spraying.
- 1        4. The method according to claim 2, further comprising drying said  
2 carbon black before deposition of said second layer.
- 1        5. The method according to claim 2, wherein said carbon black layer  
2 has a thickness between about 0.01 micron to about 10 microns.
- 1        6. The method according to claim 5, wherein said carbon black layer  
2 has a thickness between about 0.1 micron to about 1 micron.
- 1        7. The method according to claim 1, further comprising depositing  
2 said first layer of conducting material through a mask.
- 1        8. The method according to claim 7, wherein said mask comprises a  
2 plurality of apertures.
- 1        9. The method according to claim 1, wherein said deposition of said  
2 first layer of conducting material comprises robotic amateur.
- 1        10. The method according to claim 1, wherein said deposition of said  
2 second layer of said polymer film comprises robotic amateur.
- 1        11. The method according to claim 1, further comprising depositing  
2 said second layer of polymer film through a mask.

1                   **12.**    The method according to claim 11, wherein said mask comprises a  
2    plurality of apertures.

1                   **13.**    The method according to claim 1, further comprising processing  
2    said second layer of polymer film after depositing upon said first layer of conducting  
3    material.

1                   **14.**    The method according to claim 13, wherein said processing is a  
2    member selected from the group consisting of vacuum processing, photo-active  
3    polymerization and cross-linking.

1                   **15.**    The method according to claim 1, wherein said sensor is an array  
2    of sensors having a first sensor and a second sensor.

1                   **16.**    The method according to claim 15, wherein said first sensor is  
2    compositionally different than said second sensor.

1                   **17.**    The method according to claim 15, wherein said first sensor has a  
2    different polymer film layer than said second sensor.

1                   **18.**    The method according to claim 1, wherein said substrate comprises  
2    a dielectric material.

1                   **19.**    The method according to claim 1, wherein said substrate further  
2    comprises a member selected from the group consisting of a heater, a thermistor and a  
3    combination thereof.

1                   **20.**    The method according to claim 1, wherein said substrate further  
2    comprises a member selected from the group consisting of a temperature probe, humidity  
3    probe and a combination thereof.

1                   **21.**    A method for fabricating a sensor on a substrate having a pair of  
2    electrodes, said method comprising:

3                   depositing a first layer of conducting material onto said substrate having a  
4    pair of electrodes to form a substrate having a conducting material disposed thereon;

5                   processing said substrate having a conducting material disposed thereon to  
6    remove any solvent;

7                   depositing a second layer of polymer film onto said first layer of  
8   conducting material to form a fabricated sensor; and  
9                   processing said fabricated sensor to cure said second layer of polymer  
10   film.

1                   **22.**   The method according to claim 21, wherein said sensor is an array  
2   of sensors.

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